Power line chokes

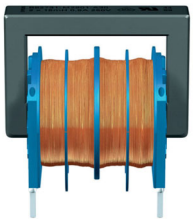
Current-compensated D core double chokes
250 V AC, 3.3 … 100 mH, 0.35 … 1.8 A, +40 °C

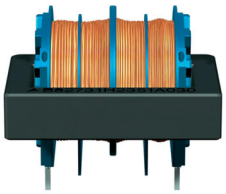
Series/Type: **B82731M/H**

Date: February 2025

Current-compensated D core double chokes

Rated voltage 250 V AC
Rated current 0.35 ... 1.8 A / +40 °C
Nominal inductance 3.3 ... 100 mH


B82731M


B82731H

Construction

- Current-compensated double choke
- Closed rectangular ferrite core
- Closed plastic coil former (UL 94 V-0)[1)]
- Without encapsulation
- 2-section winding
- Clearance and creepage distances ≥ 3 mm

Features

- High resonance frequency due to 2-section winding
- Approx. 1% stray inductance for symmetrical interference suppression
- Low leakage due to closed core shape
- High pulse strength
- Low whirring noise
- Suitable for wave soldering
- Design complies with EN 60938-2 (VDE 0565-2) and UL 1283
- UL[2)] and ENEC (VDE) approvals
- Recyclable owing to omission of encapsulation and glue
- RoHS-compatible

Applications

- Suppression of common-mode interferences
- Compact switch-mode power applications
- Electronic ballasts in lamps

Terminals

- Base material CuNi18Zn20
- Layer composition Ni, Sn
- Hot-dipped
- Pins 0.6 × 0.6 (mm)
- Lead spacing 10 × 12.5 (mm)

Marking

- B82731M: Product brand, nominal inductance, rated current, ordering code, approval signs, date of manufacture (YYWW)
- B82731H: Product brand, ordering code

Delivery mode

- Blister tray in cardboard box
- Delivery in tube magazine is available on request

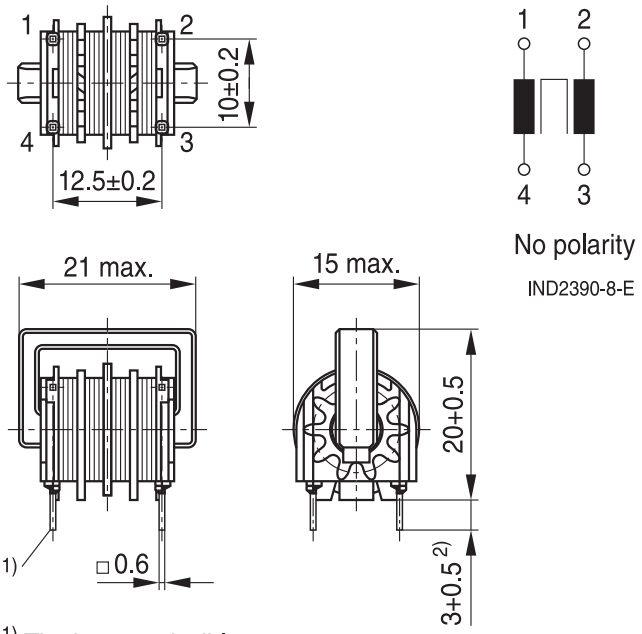
1) Additionally certified values:

Glow wire flammability index (GWFI to IEC 60695-2-12):	+850 °C
Glow wire ignition temperature (GWIT to IEC 60695-2-13):	+775 °C
Glow wire test (GWT to IEC 60695-2-11):	+750 °C, 2 s / 850 °C, 30 s
Comparative tracking index (CTI to IEC 60112):	175 V
Ball pressure test (BP to IEC 60695-10-2):	+125 °C

2) UL approval with 300 V AC.

Dimensional drawings and pin configurations

Vertical version (B82731M)



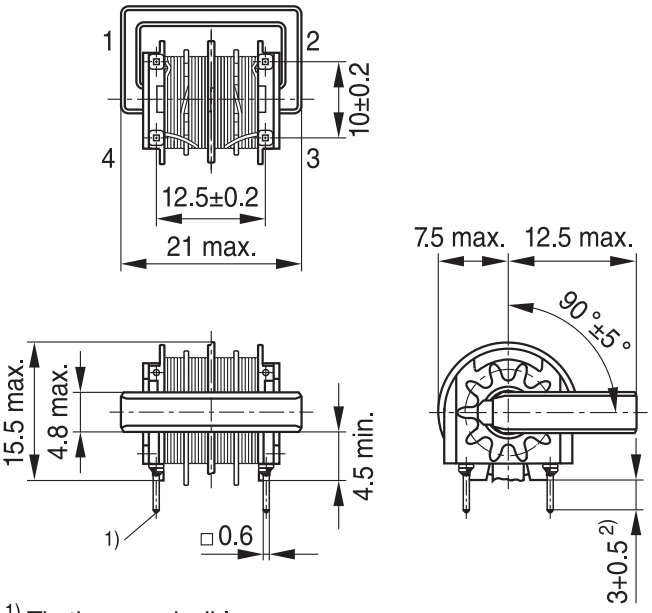
No polarity

IND2390-8-E

1) Tin tips permissible
2) Dimension does not include tin tip

IND2437-E-E

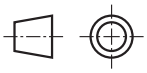
Horizontal version (B82731H)



1) Tin tips permissible
2) Dimension does not include tin tip

IND2438-R-E

Part tolerances to ISO 2768-c / ISO 8015.
Size ISO 14405 Ⓔ
All dimensions in mm



IND2140-B-E

Technical data and measuring conditions

Rated voltage V_R	250 V AC (50/60 Hz)
Test voltage V_{test}	1500 V AC, 2 s (line/line)
Rated temperature T_R	+40 °C
Rated current I_R	Referred to 50 Hz and rated temperature
Nominal inductance L_N	Measured with Agilent 4284A at 10 kHz, 0.1 mA, +20 °C. Inductance is specified per winding.
Inductance tolerance	–30/+50% at +20 °C
Inductance decrease $\Delta L/L_0$	< 10% at DC magnetic bias with I_R, +20 °C
Stray inductance $L_{stray,typ}$	Measured with Agilent 4284A at 10 kHz, 5 mA, +20 °C, typ. values
DC resistance R_{typ}	Measured at +20 °C, typical values, specified per winding
Solderability (lead-free)	Sn96.5Ag3.0Cu0.5: +(245 ±3) °C, (3 ±0.3) s Wetting of soldering area ≥ 95% (to IEC 60068-2-20, test Ta)
Resistance to soldering heat (wave soldering)	+(260 ±5) °C, (10 ±1) s (to IEC 60068-2-20, test Tb)
Climatic category	40/125/56 (to IEC 60068-1)
Storage conditions (packaged)	–25 °C … +40 °C, ≤ 75% RH
Weight	Approx. 8 g
Approvals	IEC EN 60938-2, UL 1283 (E70122)

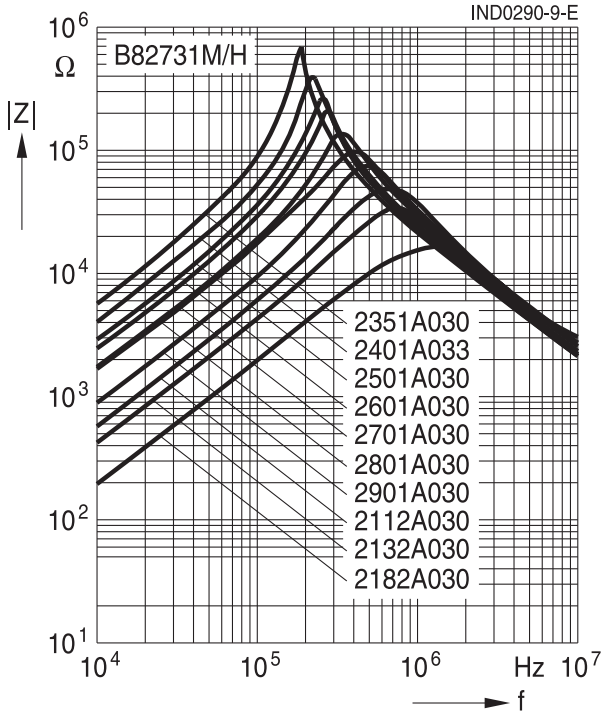
Characteristics and ordering codes

I_R	L_N	$L_{stray,typ}$	R_{typ}	Ordering code		Approvals	
A	mH	µH	mΩ	Vertical version	Horizontal version		
0.35	100	1000	4500	B82731M2351A030	B82731H2351A030	×	×
0.4	68	700	3000	B82731M2401A033	B82731H2401A033	×	×
0.5	47	470	2000	B82731M2501A030	B82731H2501A030	×	×
0.6	39	390	1500	B82731M2601A030	B82731H2601A030	×	×
0.7	27	270	1000	B82731M2701A030	B82731H2701A030	×	×
0.8	22	220	800	B82731M2801A030	B82731H2801A030	×	×
0.9	15	150	600	B82731M2901A030	B82731H2901A030	×	×
1.1	10	100	400	B82731M2112A030	B82731H2112A030	×	×
1.3	6.8	70	280	B82731M2132A030	B82731H2132A030	×	×
1.8	3.3	35	140	B82731M2182A030	B82731H2182A030	×	×

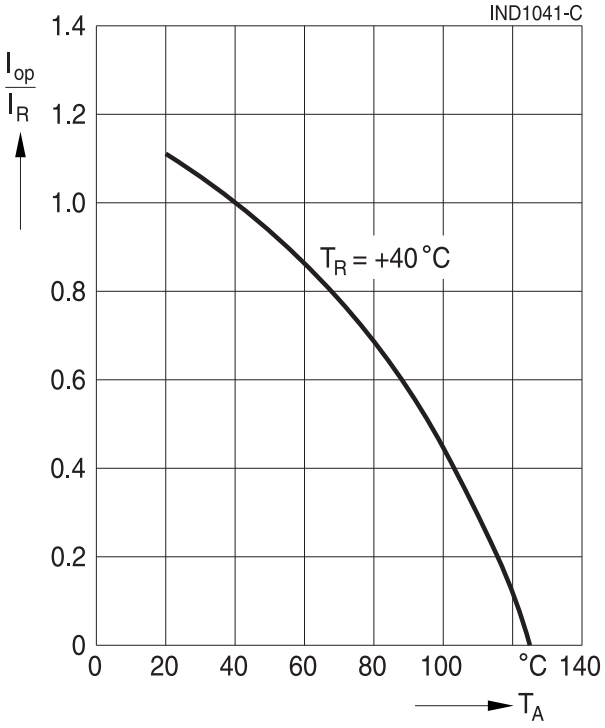
× = approval granted

Sample kit available. Ordering code: B82731X001
For more information refer to chapter “Sample kits”.

Impedance |Z| versus frequency f
measured with windings in parallel at +20 °C, typical values



Current derating I_{op}/I_R versus ambient temperature T_A



Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition), online catalogs and in the data sheets.
  - Particular attention should be paid to the derating curves, if given. Derating applies in the case the ambient temperature in application exceeds the rated temperature of the component.
  - Ensure the operation temperature of the component in application not to exceed the maximum specified value or the upper climatic category temperature.
  - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pins only. Temperatures specified in relation to reflow soldering can also refer to the pins or terminals for products with larger thermal mass, as in such cases, the temperature difference to the top of the component is too big (e.g., high proportion of core within the component).
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. It is possible for washing varnish agent residues to have a negative effect in the long−term on wire insulation.

  Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g., ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.
- The following points must be observed if the components are potted, sealed, or varnished in customer applications:
  - Many potting, sealing, or varnishing materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
  - It is necessary to check whether the potting, sealing or varnishing materials used attack or destroy the wire insulation, plastics, or glue.
  - The effect of the potting, sealing, or varnishing materials may change the high−frequency behavior of the components.
- Magnetic core materials such as ferrites are sensitive to direct impact. This can cause the core material to flake or lead to breakage of the magnetic core material.
- Any type of tension or pressure on the product may result in damage and affect its functionality and reliability.
  - The products are only to be attached to fixings or mounting holes provided for this purpose in accordance with the data sheet.
  - If additional mechanical forces are applied to the component, e.g., application of gap pads, it is necessary to check whether they attack or destroy any part of the component.
  - It is not permitted for the product specified in the data sheet to assume a mechanical function in the final application.
- Inductance value can drop if external metallic or magnetic parts will be put close to the coil or into the air gap of the coil or core or magnetic material.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

Release 2024-08-08

Display of ordering codes for TDK Electronics products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications, on the company website, or in order-related documents such as shipping notes, order confirmations and product labels. **The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products**. Detailed information can be found on the Internet under www.tdk-electronics.tdk.com/orderingcodes.

Important notes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application**. As a rule we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.

2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified**. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.

3. **The warnings, cautions and product-specific notes must be observed**.

4. In order to satisfy certain technical requirements, **some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous)**. Useful information on this will be found in our Material Data Sheets on the Internet (www.tdk-electronics.tdk.com/material). Should you have any more detailed questions, please contact our sales offices.

5. We constantly strive to improve our products. Consequently, **the products described in this publication may change from time to time**. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order.
   We also **reserve the right to discontinue production and delivery of products**. Consequently, we cannot guarantee that all products named in this publication will always be available. The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.

6. Unless otherwise agreed in individual contracts, **all orders are subject to our General Terms and Conditions of Supply**.

Important notes

7. **Our manufacturing sites serving the automotive business apply the IATF 16949 standard**. The IATF certifications confirm our compliance with requirements regarding the quality management system in the automotive industry. Referring to customer requirements and customer specific requirements (“CSR”) TDK always has and will continue to have the policy of respecting individual agreements. Even if IATF 16949 may appear to support the acceptance of unilateral requirements, we hereby like to emphasize that **only requirements mutually agreed upon can and will be implemented in our Quality Management System**. For clarification purposes we like to point out that obligations from IATF 16949 shall only become legally binding if individually agreed upon.
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